TE Internal #: 2304185-2

PCB Mount Header, Vertical, Wire-to-Board, 2 Position, 2.5 mm [.

098 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder,

Signal, Natural

View on TE.com >

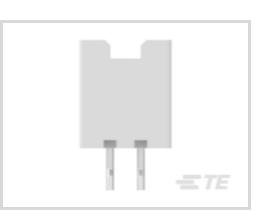


Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Wire-to-Board

Number of Positions: 2

Centerline (Pitch): 2.5 mm [.098 in]

Features

Product Type Features

PCB Connector Type	PCB Mount Header	
Connector System	Wire-to-Board	
Header Type	Fully Shrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Connector Product Type	Connector Assembly	
Configuration Features		

PCB Mount Orientation	Vertical
Number of Positions	2
Number of Rows	1

Body Features

Contact Features

(Contact Base Material	Brass	



Mating Pin Diameter	.6 mm[.024 in]		
Contact Mating Area Plating Material	Tin (Sn)		
Contact Type	Pin		
Contact Current Rating (Max)	4.2 A		
Termination Features			
Termination Post & Tail Diameter	.6 mm[.024 in]		
Termination Method to PCB	Through Hole - Solder		
Mechanical Attachment			
Mating Alignment Type	Polarization		
Mating Retention Type	Latch		
PCB Mount Alignment	Without		
Mating Retention	With		
PCB Mount Retention	With		
Connector Mounting Type	Board Mount		
Mating Alignment	With		
Housing Features			
Centerline (Pitch)	2.5 mm[.098 in]		
Housing Material	PBT		
Usage Conditions			
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]		
Operation/Application			
Circuit Application	Signal		
Industry Standards			
UL Flammability Rating	UL 94V-0		
Packaging Features			

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold

Bag



EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.

Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Customers Also Bought

















Documents

Product Drawings

EP2.5 Shrouded HDR ASSY 2P VERT w/o boss

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2304185-2_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2304185-2_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2304185-2_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English

Agency Approvals

UL Report

English